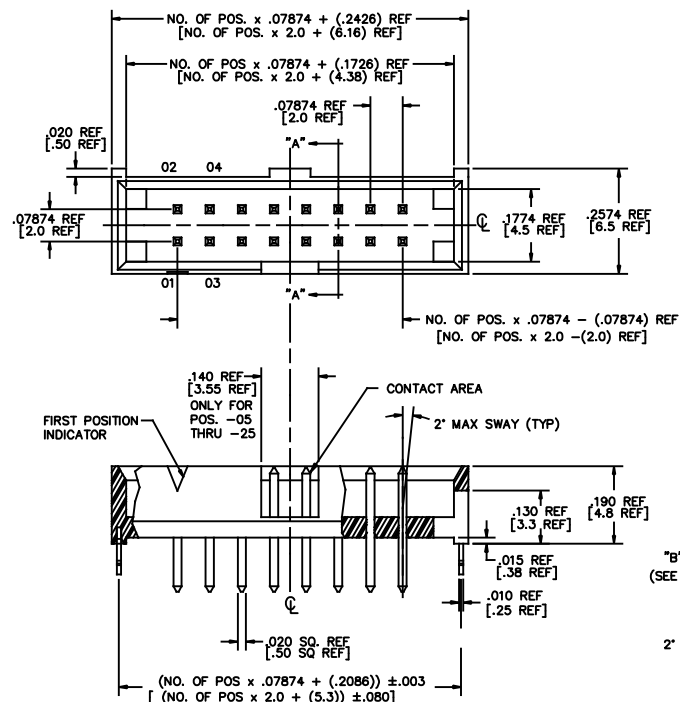
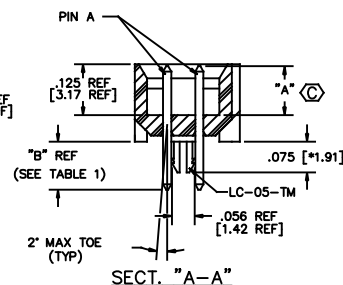


DO NOT SCALE
FROM THIS PRINTTHROUGH HOLE
FIG. 1

SECT. "A-A"

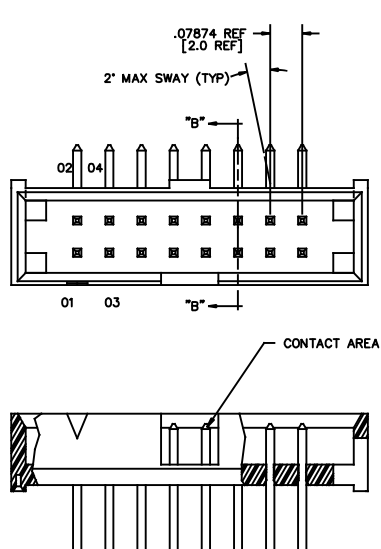
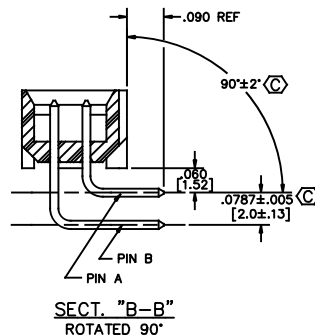
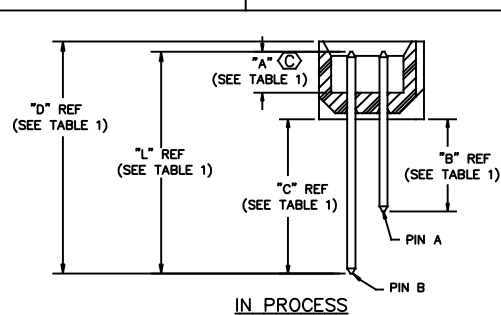


FIG. 2

-RA: RIGHT ANGLE

DIFFERENT AS SHOWN OTHERWISE SAME AS FIG. 1

SECT. "B-B"
ROTATED 90°

IN PROCESS

DIMENSIONS ARE IN INCHES

UNLESS OTHERWISE NOTED

TOLERANCES ARE:

ONE PLACE DECIMALS ± .1 [2.5] THREE PLACE DECIMALS ± .005 [.13]
TWO PLACE DECIMALS ± .01 [.3] FOUR PLACE DECIMALS ± .0010 [.025]ANGLES
± 1°TITLE:
2mm C.L. SHROUDED
TERMINAL STRIP TO
MATE WITH CABLE

DWG NO:

STMM-1XX-XX-XX-D-XX-XX
SHEET 1 OF 3

STMM-1XX-XX-XX-D-XX-XX

NO. OF POSITIONS
-02 THRU -25POLARIZED OPTION
XX = PIN NO TO BE OMITTEDTERMINAL STYLE
LEAD STYLE -01 IS STANDARD
(.100 [2.54] POST HEIGHT), LEAD STYLE -02
IS FOR MATING WITH TCSD ONLY
(.120 [3.05] POST HEIGHT) (SEE TABLE 1)

PLATING SPECIFICATIONS

- G: 20μ" GOLD IN CONTACT AREA,
3μ" GOLD ON TAIL
- T: MATTE TIN CONTACT AND TAIL
- S: 30μ" SELECTIVE GOLD IN CONTACT AREA,
MATTE TIN ON TAIL
- L: 10μ" SELECTIVE GOLD IN CONTACT AREA,
MATTE TIN ON TAIL
- F: 3μ" SELECTIVE GOLD IN CONTACT AREA,
MATTE TIN ON TAIL
- H: 30μ" GOLD IN CONTACT AREA,
3μ" GOLD ON TAIL
- SM: 30μ" SELECTIVE GOLD IN CONTACT AREA,
MATTE TIN ON TAIL
- TM: MATTE TIN CONTACT AND TAIL
- LM: 10μ" SELECTIVE GOLD IN CONTACT AREA,
MATTE TIN ON TAIL
- FM: 3μ" SELECTIVE GOLD IN CONTACT AREA,
MATTE TIN ON TAIL

OPTION

- RA: RIGHT ANGLE (SEE FIG 2 -RA & TABLE 1 SHT 1)
- SM: SURFACE MOUNT (SEE TABLE 1 SHT 1 & TABLE 2 SHT 2)
- LC: LOCKING CLIP (SEE NOTE 9)
(USE LC-05-TM FOR THROUGH HOLE STYLE, SEE FIG 1, * DIMS)
(USE LC-07-TM FOR -SM STYLE, SEE FIG 3, SHT 2 * DIMS)
- NOT AVAILABLE FOR -RA STYLE
- LEAVE BLANK FOR THROUGH HOLE (SEE FIG 1 & TABLE 1 SHT 1)
- P: PICK AND PLACE PAD (USE PPP-24, SEE FIG 4 SHT 2)
(3 POSITION MINIMUM) (NOT AVAILABLE WITH -RA OPTION)
- M: METAL PICK AND PLACE PAD (USE MPP-07, SEE FIG 5 SHT 2)
(-SM OPTION ONLY) (3 POSITION MINIMUM) (SEE NOTE 8)
(NOT AVAILABLE WITH -RA OPTION)
- TR: TAPE & REEL (SEE FIG 7 SHT 3). FOR SM OPTION ONLY.
- K: POLYIMIDE FILM PAD (SEE FIG 6, SHT 2)
(USE K-DOT-.295-.406-.005)
(NOT AVAILABLE WITH -RA OPTION)

ROW SPECIFICATION

-D: DOUBLE (USE STMM-XX-D-LC)

NOTES:

- MAX PIN ROTATION IN BODY TO BE 2°.
- PUSHOUT FORCE TO BE 1 lb. MIN.
- ⊕ REPRESENTS CRITICAL DIMS.
- DIMENSIONS IN [] ARE IN MILLIMETERS.
- FOR LOCKING CLIPS: 12 OZ. MIN RETENTION
- MEASURE AT BEND.
- ORIENTATE PINS TO REDUCE THE NUMBER OF
BANDOLIER MARKS IN THE POST AREA. (SEE TABLE 4)
- M OPTION NOT RECOMMENDED WITH -T OR -TM PLATING
OPTIONS FOR LEAD FREE PROCESSING.
- DUE TO THE HIGH AMOUNT OF INSERTION FORCE
NEEDED, THE -LC OPTION IS NOT COMPATIBLE WITH
AUTO PLACEMENT. SAMTEC RECOMMENDS MANUAL
PLACEMENT FOR ALL ASSEMBLIES WITH THE -LC OPTION.

TABLE 1

	LEAD STYLE	"A"	"B"	"C" REF	PIN A	"L" REF TERMINAL LENGTH	"D" REF	PIN B	"L" REF TERMINAL LENGTH	"D" REF
THROUGH HOLE (SEE FIG. 1)	-01	.100 [2.54]	.092 [2.3]	N/A	T-1S13-04-XX-2	.255 [6.48]	.280 [7.11]	N/A	.255 [6.48]	N/A
	-02	.120 [3.05]	.117 [3.0]	N/A	T-1S13-07-XX-2	.302 [7.67]	.307 [7.80]	N/A	.302 [7.67]	N/A
RIGHT ANGLE (SEE FIG. 2)	-01	.100 [2.5]	.232 [5.9]	.390 [9.9]	T-1S13-05-XX-2	.397 [10.08]	.422 [10.71]	T-1S13-06-X-2	.555 [14.10] REF	.580 [14.73]
	-02	.120 [3.0]	.228 [5.8]	.386 [9.8]	T-1S13-19-XX-2	.413 [10.49]	.438 [11.13]	T-1S13-22-X-2	.571 [1.50] REF	.576 [14.63]
SURFACE MOUNT (SEE FIG. 3)	-01	.100 [2.54]	.172 [4.4]	N/A	T-1S13-07-XX-2	.302 [7.67]	.327 [8.31]	N/A	SEE TABLE 2	N/A
	-02	.120 [3.05]	.173 [4.4]	N/A	T-1S13-20-XX-2	.323 [8.20]	.328 [8.33]	N/A	SEE TABLE 2	N/A

PLOT SCALE: 1=.25

MATERIAL:
BODY: LCP
COLOR: BLACKTERMINAL:
PHOSPHOR BRONZE

samtec

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PHONE (812) 944-6733 P.O. BOX 1147
CODE 55322

MADE BY: KOLB 1-28-92

STMM-1XX-XX-XX-D-XX-XX
SHEET 1 OF 3

* PROPRIETARY NOTE *

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